

**Specifications:-**

- 400 tie points
- 1 double strip, total 300 tie points
- 2 power lanes, total 100 tie points in power lanes
- Perfect for arduino shield prototyping and testing
- Plastic housing, metal contact clips
- 400 points half size solderless breadboard is a high-quality breadboard with power lanes and printed top face for easy prototyping.
- A breadboard is used to make up temporary circuits for testing or to try out an idea. No soldering is required so it is easy to change connections and replace components.

*Note: Specifications are subject to change, Photos shown above are Indicative, Actual Product can Vary.*



Export Sales: +91-9829132777  
India Sales: +91-9588842361



IT-2013, Ramchandrapura Industrial Area,  
Sitapura Extension, Jaipur-302022, India.



info@tesca.in  
www.tescaglobal.com